

## **Description**

The LP2309LT1G uses advanced trench technology and design to provide excellent  $R_{\text{DS}(\text{ON})}$  with low gate charge .This device is well suited for use as a load switch or in PWM applications.



#### **General Features**

 $V_{DS}$  =-60V,I  $_{D}$  =-2A

 $R_{DS(ON)}$  <160m $\Omega$  @  $V_{GS}$ =-10V

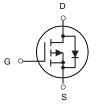
 $R_{DS(ON)}$  <200m $\Omega$  @  $V_{GS}$ =-4.5V



## **Application**

Load switch

PWM application



P-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)
LP2309LT1G	SOT-23	N9ADE	3000

#### Absolute Maximum Ratings (TA=25 ℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V <sub>DS</sub>	Drain-Source Voltage	-60	V
V <sub>G</sub> s	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current-Continuous	-2	А
Ідм	Drain Current-Pulsed (Note 1)	-8	Α
P <sub>D</sub>	Maximum Power Dissipation	1.5	W
Тл,Тѕтв	Operating Junction and Storage Temperature Range	-55 To 150	°C
Reja	Thermal Resistance,Junction-to-Ambient (Note 2)	83.3	°C/W



Electrical Characteristics (T<sub>C</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =-250μA	-60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-60V,V <sub>GS</sub> =0V	-	-	-1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =-250μA	-1.4	-2.0	-2.6	V
Drain Course On Ctate Desistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-1.5A	-	140	160	mΩ
Drain-Source On-State Resistance		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.5A	-	160	200	mΩ
Forward Transconductance	<b>g</b> Fs	V <sub>DS</sub> =-5V,I <sub>D</sub> =-1.5A		3	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ - 20\/\/ -0\/	-	444.2	-	PF
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =-30V, $V_{GS}$ =0V, F=1.0MHz	-	19.6	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	r-1.0Winz	-	17.9	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	40	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =-30V, $I_{D}$ =-1.5A,	-	35	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =-10 $V$ , $R_{G}$ =3 $\Omega$	-	15	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =-30,I <sub>D</sub> =-1.5A,	-	11.3	-	nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =-30, $I_{D}$ =-1.5A, $V_{GS}$ =-10V	-	2.7	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	VGS=-10V	-	1.6	-	nC
Drain-Source Diode Characteristics	<u> </u>					
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =-1.5A	-		-1.2	V
Diode Forward Current (Note 2)	Is		-	-	-1.6	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> =- 1.5A	-	25		nS
Reverse Recovery Charge	Qrr	$di/dt = -100A/\mu s^{(Note3)}$	-	31		nC

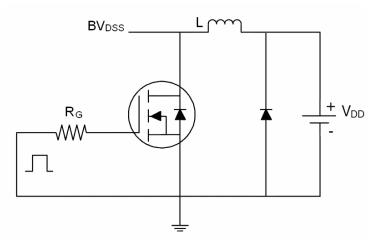
### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤  $300\mu$ s, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

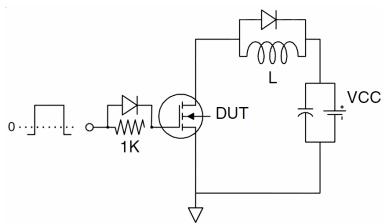


## **Test Circuit**

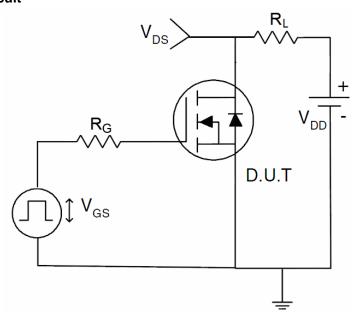
## 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit

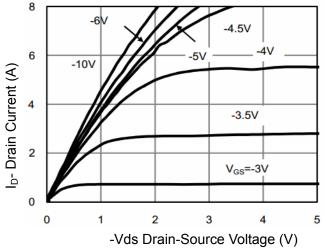


### 3) Switch Time Test Circuit

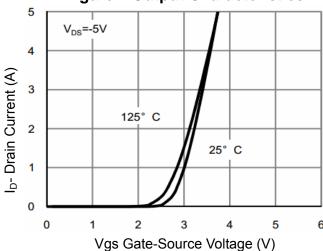




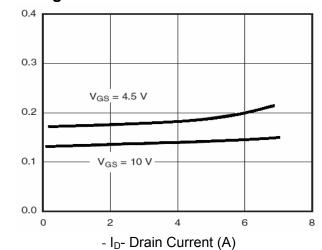
## Typical Electrical and Thermal Characteristics (Curves)



**Figure 1 Output Characteristics** 

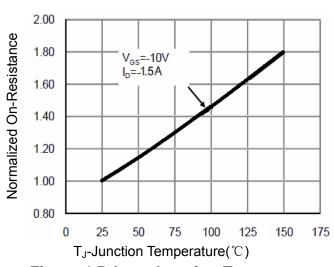


**Figure 2 Transfer Characteristics** 

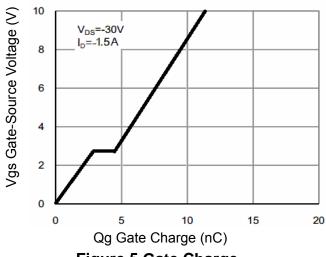


Rdson On-Resistance( ()

Figure 3 Rdson- Drain Current



**Figure 4 Rdson-Junction Temperature** 



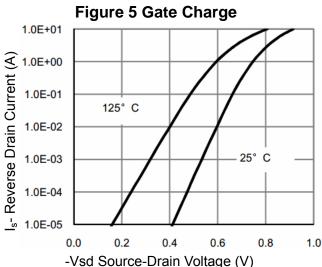


Figure 6 Source- Drain Diode Forward



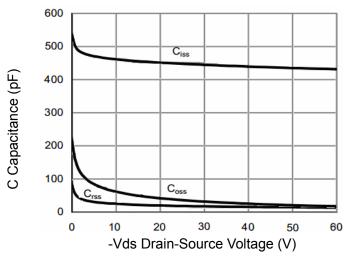
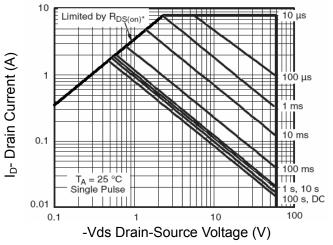


Figure 7 Capacitance vs Vds



**Figure 8 Safe Operation Area** 

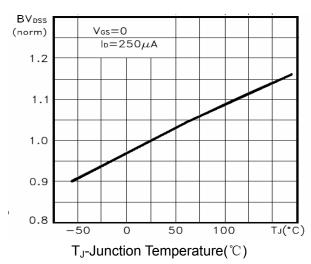


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

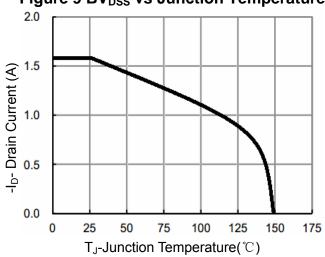
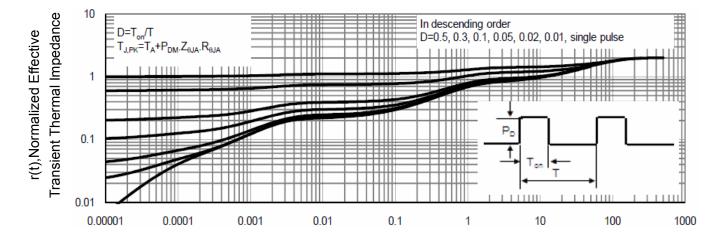


Figure 10 ID Current De-rating

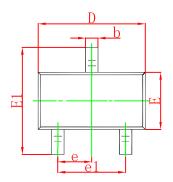


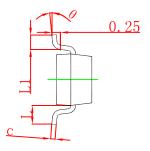
Square Wave Pluse Duration(sec)

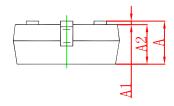
Figure 11 Normalized Maximum Transient Thermal Impedance



## **SOT-23 Package Outline Dimensions**

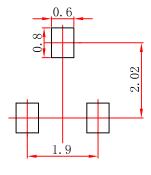






Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
E	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

## **SOT-23 Suggested Pad Layout**



- Note: 1.Controlling dimension: in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.



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